

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Ki-Don Lee, et al.

TI-34867

Examiner: TBD

Serial No: TBD

Art Unit: TBD

Filed: Herewith

For: Mechanical Cooling Fin for Interconnects

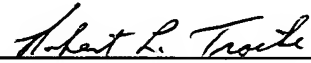
PRELIMINARY AMENDMENT

Assistant Commissioner for Patents

Washington, D. C. 20231

Dear Sir:

"EXPRESS MAILING" Mailing Label No. EV334469290US 1
hereby certify that this paper is being deposited with the U.S.
Postal Service Express Mail Post Office to Addressee Service
under 37 CFR 1.10 on the date shown below and is addressed to
the Assistant Commissioner for Patents, Washington, D.C.
20231.

 10/17/03
Robert L. Troike, Reg. No. 24,183 Date

This application claims priority under 35 USC 119 (e)(1) of provisional application number 60/436,660 filed 12/30/02.

Prior to the examination of the above-identified application, please amend the specification by inserting before the first line the sentence:

--This application claims priority under 35 USC § 119(e)(1) of provisional application number 60/436,660 filed 12/30/02.--

Respectfully submitted,



Robert L. Troike
Attorney for Applicants
Reg. No. 24,183

Texas Instruments Incorporated
P. O. Box 655474, MS 3999
Dallas, TX 75265
(301) 259-2089